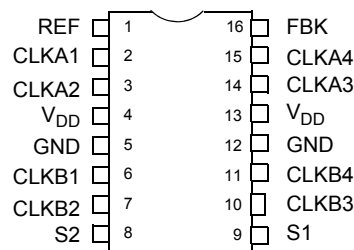


## Contents

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## Pinouts

Figure 1. 16-pin SOIC pinout (Top View)



## Pin Definitions

16-pin SOIC

| Pin | Signal               | Description               |
|-----|----------------------|---------------------------|
| 1   | REF <sup>[1]</sup>   | Input reference frequency |
| 2   | CLKA1 <sup>[2]</sup> | Clock output, Bank A      |
| 3   | CLKA2 <sup>[2]</sup> | Clock output, Bank A      |
| 4   | V <sub>DD</sub>      | Power supply voltage      |
| 5   | GND                  | Power supply ground       |
| 6   | CLKB1 <sup>[2]</sup> | Clock output, Bank B      |
| 7   | CLKB2 <sup>[2]</sup> | Clock output, Bank B      |
| 8   | S2 <sup>[3]</sup>    | Select input, bit 2       |
| 9   | S1 <sup>[3]</sup>    | Select input, bit 1       |
| 10  | CLKB3 <sup>[2]</sup> | Clock output, Bank B      |
| 11  | CLKB4 <sup>[2]</sup> | Clock output, Bank B      |
| 12  | GND                  | Power supply ground       |
| 13  | V <sub>DD</sub>      | Power supply voltage      |
| 14  | CLKA3 <sup>[2]</sup> | Clock output, Bank A      |
| 15  | CLKA4 <sup>[2]</sup> | Clock output, Bank A      |
| 16  | FBK                  | PLL feedback input        |

## Select Input Decoding

| S2 | S1 | CLOCK A1–A4           | CLOCK B1–B4           | Output Source | PLL Shutdown |
|----|----|-----------------------|-----------------------|---------------|--------------|
| 0  | 0  | Tri-state             | Tri-state             | PLL           | Y            |
| 0  | 1  | Driven                | Tri-state             | PLL           | N            |
| 1  | 0  | Driven <sup>[4]</sup> | Driven <sup>[4]</sup> | Reference     | Y            |
| 1  | 1  | Driven                | Driven                | PLL           | N            |

### Notes

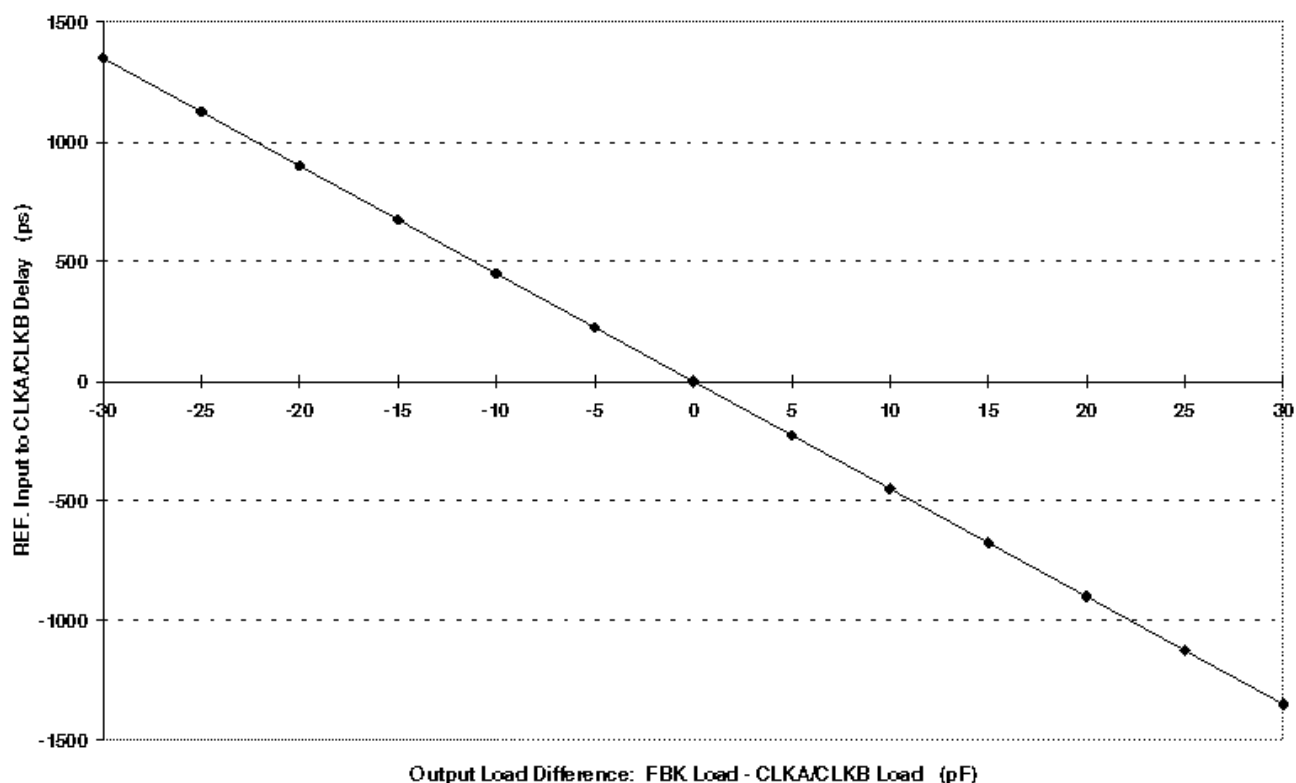
1. Weak pull down.
2. Weak pull down on all outputs.
3. Weak pull ups on these inputs.
4. Outputs inverted and PLL bypass mode for 2308-2 and 2308-3, S2 = 1 and S1 = 0.

## Available CY2308 Configurations

| Device    | Feedback From <sup>[5]</sup> | Bank A Frequency | Bank B Frequency         |
|-----------|------------------------------|------------------|--------------------------|
| CY2308-1  | Bank A or Bank B             | Reference        | Reference                |
| CY2308-1H | Bank A or Bank B             | Reference        | Reference                |
| CY2308-2  | Bank A                       | Reference        | Reference / 2            |
| CY2308-2  | Bank B                       | 2 × Reference    | Reference                |
| CY2308-3  | Bank A                       | 2 × Reference    | Reference <sup>[6]</sup> |
| CY2308-3  | Bank B                       | 4 × Reference    | 2 × Reference            |
| CY2308-4  | Bank A or Bank B             | 2 × Reference    | 2 × Reference            |
| CY2308-5H | Bank A or Bank B             | Reference / 2    | Reference / 2            |

## Zero Delay and Skew Control

Figure 2. REF. Input to CLKA/CLKB Delay Versus Difference in Loading between FBK Pin and CLKA/CLKB Pins



To close the feedback loop of the CY2308, the user has to connect any one of the eight available output pins to FBK pin. The output driving the FBK pin drives a total load of 7 pF plus any additional load that it drives. The relative loading of this output to the remaining outputs adjusts the input-output delay as shown in the [Figure 2](#).

For applications requiring zero input-output delay, all outputs including the one providing feedback is equally loaded.

If input-output delay adjustments are required, use the [Zero Delay and Skew Control](#) graph to calculate loading differences between the feedback output and remaining outputs.

For zero output-output skew, outputs are loaded equally. For further information on using CY2308, refer to the application note [AN1234 - Understanding Cypress's Zero Delay Buffers](#).

### Notes

5. User has to select one of the available outputs that drive the feedback pin and need to connect selected output pin to FBK pin externally.
6. Output phase is indeterminant (0 ° or 180 ° from input clock). If phase integrity is required, use CY2308-2.

## Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Supply voltage to ground potential ..... -0.5 V to +7.0 V

DC input voltage (except REF) ..... -0.5 V to  $V_{DD} + 0.5$  V

DC input voltage REF ..... -0.5 V to 7 V

Storage temperature ..... -65 °C to +150 °C

Junction temperature ..... 150 °C

Static discharge voltage

(MIL-STD-883, Method 3015) ..... >2000 V

## Operating Conditions

For Commercial Temperature Devices

| Parameter | Description                                                                                          | Min  | Max | Unit |
|-----------|------------------------------------------------------------------------------------------------------|------|-----|------|
| $V_{DD}$  | Supply voltage                                                                                       | 3.0  | 3.6 | V    |
| $T_A$     | Operating temperature (ambient temperature)                                                          | 0    | 70  | °C   |
| $C_L$     | Load capacitance, below 100 MHz                                                                      | –    | 30  | pF   |
|           | Load capacitance, from 100 MHz to 133 MHz                                                            | –    | 15  | pF   |
| $C_{IN}$  | Input capacitance [7]                                                                                | –    | 7   | pF   |
| $t_{PU}$  | Power up time for all $V_{DD}$ 's to reach minimum specified voltage (power ramps must be monotonic) | 0.05 | 50  | ms   |

## Electrical Characteristics

For Commercial Temperature Devices

| Parameter          | Description               | Test Conditions                                                   | Min | Max             | Unit |
|--------------------|---------------------------|-------------------------------------------------------------------|-----|-----------------|------|
| $V_{IL}$           | Input LOW voltage         |                                                                   | –   | 0.8             | V    |
| $V_{IH}$           | Input HIGH voltage        |                                                                   | 2.0 | –               | V    |
| $I_{IL}$           | Input LOW current         | $V_{IN} = 0$ V                                                    | –   | 50.0            | μA   |
| $I_{IH}$           | Input HIGH current        | $V_{IN} = V_{DD}$                                                 | –   | 100.0           | μA   |
| $V_{OL}$           | Output LOW voltage [8]    | $I_{OL} = 8$ mA (-1, -2, -3, -4)<br>$I_{OL} = 12$ mA (-1H, -5H)   | –   | 0.4             | V    |
| $V_{OH}$           | Output HIGH voltage [8]   | $I_{OH} = -8$ mA (-1, -2, -3, -4)<br>$I_{OH} = -12$ mA (-1H, -5H) | 2.4 | –               | V    |
| $I_{DD}$ (PD mode) | Power down supply current | REF = 0 MHz                                                       | –   | 12.0            | μA   |
| $I_{DD}$           | Supply current            | Unloaded outputs, 100 MHz REF, select inputs at $V_{DD}$ or GND   | –   | 45.0            | mA   |
|                    |                           |                                                                   | –   | 70.0 (-1H, -5H) | mA   |
|                    |                           | Unloaded outputs, 66 MHz REF (-1, -2, -3, -4)                     | –   | 32.0            | mA   |
|                    |                           | Unloaded outputs, 33 MHz REF (-1, -2, -3, -4)                     | –   | 18.0            | mA   |

### Notes

7. Applies to both Ref clock and FBK.

8. Parameter is guaranteed by design and characterization. Not 100% tested in production.

## Operating Conditions

For Industrial Temperature Devices

| Parameter       | Description                                                                                               | Min  | Max | Unit |
|-----------------|-----------------------------------------------------------------------------------------------------------|------|-----|------|
| V <sub>DD</sub> | Supply voltage                                                                                            | 3.0  | 3.6 | V    |
| T <sub>A</sub>  | Operating temperature (ambient temperature)                                                               | -40  | 85  | °C   |
| C <sub>L</sub>  | Load capacitance, below 100 MHz                                                                           | –    | 30  | pF   |
|                 | Load capacitance, from 100 MHz to 133 MHz                                                                 | –    | 15  | pF   |
| C <sub>IN</sub> | Input capacitance <sup>[9]</sup>                                                                          | –    | 7   | pF   |
| t <sub>PU</sub> | Power up time for all V <sub>DDs</sub> to reach minimum specified voltage (power ramps must be monotonic) | 0.05 | 50  | ms   |

## Electrical Characteristics

For Industrial Temperature Devices

| Parameter                 | Description                             | Test Conditions                                                                 | Min | Max           | Unit |
|---------------------------|-----------------------------------------|---------------------------------------------------------------------------------|-----|---------------|------|
| V <sub>IL</sub>           | Input LOW voltage                       |                                                                                 | –   | 0.8           | V    |
| V <sub>IH</sub>           | Input HIGH voltage                      |                                                                                 | 2.0 | –             | V    |
| I <sub>IL</sub>           | Input LOW current                       | V <sub>IN</sub> = 0 V                                                           | –   | 50.0          | μA   |
| I <sub>IH</sub>           | Input HIGH current                      | V <sub>IN</sub> = V <sub>DD</sub>                                               | –   | 100.0         | μA   |
| V <sub>OL</sub>           | Output LOW voltage <sup>[10, 11]</sup>  | I <sub>OL</sub> = 8 mA (-1, -2, -3, -4)<br>I <sub>OL</sub> = 12 mA (-1H, -5H)   | –   | 0.4           | V    |
| V <sub>OH</sub>           | Output HIGH voltage <sup>[10, 11]</sup> | I <sub>OH</sub> = -8 mA (-1, -2, -3, -4)<br>I <sub>OH</sub> = -12 mA (-1H, -5H) | 2.4 | –             | V    |
| I <sub>DD</sub> (PD mode) | Power down supply current               | REF = 0 MHz                                                                     | –   | 25.0          | μA   |
| I <sub>DD</sub>           | Supply current                          | Unloaded outputs, 100 MHz, Select inputs at V <sub>DD</sub> or GND              | –   | 45.0          | mA   |
|                           |                                         |                                                                                 | –   | 70 (-1H, -5H) | mA   |
|                           |                                         | Unloaded outputs, 66 MHz REF (-1, -2, -3, -4)                                   | –   | 35.0          | mA   |
|                           |                                         | Unloaded outputs, 66 MHz REF (-1, -2, -3, -4)                                   | –   | 20.0          | mA   |

## Thermal Resistance

| Parameter <sup>[12]</sup> | Description                              | Test Conditions                                                                                                             | 16-pin SOIC | 16-pin TSSOP | Unit |
|---------------------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-------------|--------------|------|
| θ <sub>JA</sub>           | Thermal resistance (junction to ambient) | Test conditions follow standard test methods and procedures for measuring thermal impedance, in accordance with EIA/JESD51. | 111         | 117          | °C/W |
| θ <sub>JC</sub>           | Thermal resistance (junction to case)    |                                                                                                                             | 60          | 22           | °C/W |

### Notes

9. Applies to both Ref clock and FBK.
10. Parameter is guaranteed by design and characterization. Not 100% tested in production.
11. All parameters are specified with loaded outputs.
12. These parameters are guaranteed by design and are not tested.

## Switching Characteristics

For Commercial Temperature Devices

| Parameter <sup>[13]</sup> | Description                                                               | Test Conditions                                                          | Min  | Typ  | Max                                    | Unit |
|---------------------------|---------------------------------------------------------------------------|--------------------------------------------------------------------------|------|------|----------------------------------------|------|
| $F_{in}$                  | Input frequency                                                           | –                                                                        | 10   | –    | 133.3                                  | MHz  |
| $t_1$                     | Output frequency                                                          | 30 pF load                                                               | 10   | –    | 100<br>(-1, -2, -3, -4)<br>66.67 (-5H) | MHz  |
| $t_1$                     | Output frequency                                                          | 20 pF load, -1H, -5H devices                                             | 10   | –    | 133.3 (-1H)<br>66.67 (-5H)             | MHz  |
| $t_1$                     | Output frequency                                                          | 15 pF load, -1, -2, -3, -4 devices                                       | 10   | –    | 133.3                                  | MHz  |
| $t_{PD}$                  | Duty cycle <sup>[13]</sup> = $t_2 \div t_1$<br>(-1, -2, -3, -4, -1H, -5H) | Measured at 1.4 V, $F_{OUT} = 66.66$ MHz, 30 pF load                     | 40.0 | 50.0 | 60.0                                   | %    |
| $t_{PD}$                  | Duty cycle <sup>[13]</sup> = $t_2 \div t_1$<br>(-1, -2, -3, -4, -1H, -5H) | Measured at 1.4 V, $F_{OUT} < 50$ MHz, 15 pF load                        | 45.0 | 50.0 | 55.0                                   | %    |
| $t_3$                     | Rise time <sup>[13]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 30 pF load                             | –    | –    | 2.20                                   | ns   |
| $t_3$                     | Rise time <sup>[13]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 15 pF load                             | –    | –    | 1.50                                   | ns   |
| $t_3$                     | Rise time <sup>[13]</sup> (-1H, -5H)                                      | Measured between 0.8 V and 2.0 V, 30 pF load                             | –    | –    | 1.50                                   | ns   |
| $t_4$                     | Fall time <sup>[13]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 30 pF load                             | –    | –    | 2.20                                   | ns   |
| $t_4$                     | Fall time <sup>[13]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 15 pF load                             | –    | –    | 1.50                                   | ns   |
| $t_4$                     | Fall time <sup>[13]</sup> (-1H, -5H)                                      | Measured between 0.8 V and 2.0 V, 30 pF load                             | –    | –    | 1.25                                   | ns   |
| $t_5$                     | Output to output skew on same Bank <sup>[13]</sup> (-1, -2, -3, -4)       | All outputs equally loaded                                               | –    | –    | 200                                    | ps   |
|                           | Output to output skew (-1H, -5H)                                          | All outputs equally loaded                                               | –    | –    | 200                                    | ps   |
|                           | Output Bank A to output Bank B skew (-1, -4, -5H)                         | All outputs equally loaded                                               | –    | –    | 200                                    | ps   |
|                           | Output Bank A to output Bank B skew (-2, -3)                              | All outputs equally loaded                                               | –    | –    | 400                                    | ps   |
| $t_6$                     | Delay, REF rising edge to FBK rising edge <sup>[13]</sup>                 | Measured at $V_{DD}/2$                                                   | –    | 0    | ±250                                   | ps   |
| $t_7$                     | Device to device skew <sup>[13]</sup>                                     | Measured at $V_{DD}/2$ on the FBK pins of devices                        | –    | 0    | 700                                    | ps   |
| $t_8$                     | Output slew rate <sup>[13]</sup>                                          | Measured between 0.8 V and 2.0 V on -1H, -5H device using Test Circuit 2 | 1    | –    | –                                      | V/ns |
| $t_J$                     | Cycle to cycle Jitter <sup>[13]</sup> (-1, -1H, -4, -5H)                  | Measured at 66.67 MHz, loaded outputs, 15 pF load                        | –    | 75   | 200                                    | ps   |
|                           |                                                                           | Measured at 66.67 MHz, loaded outputs, 30 pF load                        | –    | –    | 200                                    | ps   |
|                           |                                                                           | Measured at 133.3 MHz, loaded outputs, 15 pF load                        | –    | –    | 100                                    | ps   |
| $t_J$                     | Cycle to cycle Jitter <sup>[13]</sup> (-2, -3)                            | Measured at 66.67 MHz, loaded outputs, 30 pF load                        | –    | –    | 400                                    | ps   |
|                           |                                                                           | Measured at 66.67 MHz, loaded outputs, 15 pF load                        | –    | –    | 400                                    | ps   |
| $t_{LOCK}$                | PLL lock time <sup>[13]</sup>                                             | Stable power supply, valid clocks presented on REF and FBK pins          | –    | –    | 1.0                                    | ms   |

### Note

<sup>13</sup>. All parameters are specified with loaded outputs.

## Switching Characteristics

For Industrial Temperature Devices

| Parameter <sup>[14]</sup> | Description                                                                   | Test Conditions                                                          | Min  | Typ  | Max                                 | Unit |
|---------------------------|-------------------------------------------------------------------------------|--------------------------------------------------------------------------|------|------|-------------------------------------|------|
| $F_{in}$                  | Input frequency                                                               | —                                                                        | 10   | —    | 133.3                               | MHz  |
| $t_1$                     | Output frequency                                                              | 30 pF load                                                               | 10   | —    | 100 (-1, -2, -3, -4)<br>66.67 (-5H) | MHz  |
| $t_1$                     | Output frequency                                                              | 20 pF load, -1H, -5H devices                                             | 10   | —    | 133.3 (-1H)<br>66.67 (-5H)          | MHz  |
| $t_1$                     | Output frequency                                                              | 15 pF load, -1, -2, -3, -4 devices                                       | 10   | —    | 133.3                               | MHz  |
| $t_{PD}$                  | Duty cycle <sup>[14, 15]</sup> = $t_2 \div t_1$<br>(-1, -2, -3, -4, -1H, -5H) | Measured at 1.4 V, $F_{OUT} = 66.66$ MHz, 30 pF load                     | 40.0 | 50.0 | 60.0                                | %    |
| $t_{PD}$                  | Duty cycle <sup>[14, 15]</sup> = $t_2 \div t_1$<br>(-1, -2, -3, -4, -1H, -5H) | Measured at 1.4 V, $F_{OUT} < 50$ MHz, 15 pF load                        | 45.0 | 50.0 | 55.0                                | %    |
| $t_3$                     | Rise time <sup>[14, 15]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 30 pF load                             | —    | —    | 2.50                                | ns   |
| $t_3$                     | Rise time <sup>[14, 15]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 15 pF load                             | —    | —    | 1.50                                | ns   |
| $t_3$                     | Rise time <sup>[14, 15]</sup> (-1H, -5H)                                      | Measured between 0.8 V and 2.0 V, 30 pF load                             | —    | —    | 1.50                                | ns   |
| $t_4$                     | Fall time <sup>[14, 15]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 30 pF load                             | —    | —    | 2.50                                | ns   |
| $t_4$                     | Fall time <sup>[14, 15]</sup> (-1, -2, -3, -4)                                | Measured between 0.8 V and 2.0 V, 15 pF load                             | —    | —    | 1.50                                | ns   |
| $t_4$                     | Fall time <sup>[14, 15]</sup> (-1H, -5H)                                      | Measured between 0.8 V and 2.0 V, 30 pF load                             | —    | —    | 1.25                                | ns   |
| $t_5$                     | Output to output skew on same Bank <sup>[14, 15]</sup> (-1, -2, -3, -4)       | All outputs equally loaded                                               | —    | —    | 200                                 | ps   |
|                           | Output to output skew (-1H, -5H)                                              | All outputs equally loaded                                               | —    | —    | 200                                 | ps   |
|                           | Output Bank A to output Bank B skew (-1, -4, -5H)                             | All outputs equally loaded                                               | —    | —    | 200                                 | ps   |
|                           | Output Bank A to output Bank B skew (-2, -3)                                  | All outputs equally loaded                                               | —    | —    | 400                                 | ps   |
| $t_6$                     | Delay, REF rising edge to FBK rising edge <sup>[14, 15]</sup>                 | Measured at $V_{DD}/2$                                                   | —    | 0    | ±250                                | ps   |
| $t_7$                     | Device to device skew <sup>[14, 15]</sup>                                     | Measured at $V_{DD}/2$ on the FBK pins of devices                        | —    | 0    | 700                                 | ps   |
| $t_8$                     | Output slew rate <sup>[14, 15]</sup>                                          | Measured between 0.8 V and 2.0 V on -1H, -5H device using Test Circuit 2 | 1    | —    | —                                   | V/ns |
| $t_J$                     | Cycle to cycle Jitter <sup>[14, 15]</sup> (-1, -1H, -4, -5H)                  | Measured at 66.67 MHz, loaded outputs, 15 pF load                        | —    | 75   | 200                                 | ps   |
|                           |                                                                               | Measured at 66.67 MHz, loaded outputs, 30 pF load                        | —    | —    | 200                                 | ps   |
|                           |                                                                               | Measured at 133.3 MHz, loaded outputs, 15 pF load                        | —    | —    | 100                                 | ps   |
| $t_J$                     | Cycle to cycle Jitter <sup>[14, 15]</sup> (-2, -3)                            | Measured at 66.67 MHz, loaded outputs, 30 pF load                        | —    | —    | 400                                 | ps   |
|                           |                                                                               | Measured at 66.67 MHz, loaded outputs, 15 pF load                        | —    | —    | 400                                 | ps   |
| $t_{LOCK}$                | PLL lock time <sup>[14, 15]</sup>                                             | Stable power supply, valid clocks presented on REF and FBK pins          | —    | —    | 1.0                                 | ms   |

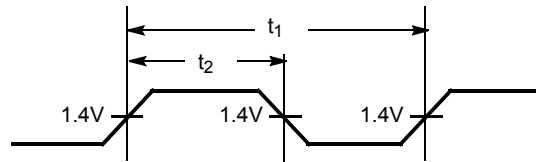
### Notes

14. All parameters are specified with loaded outputs.

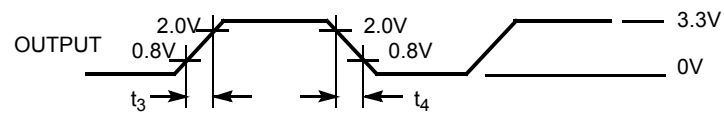
15. Parameter is guaranteed by design and characterization. Not 100% tested in production.

## Switching Waveforms

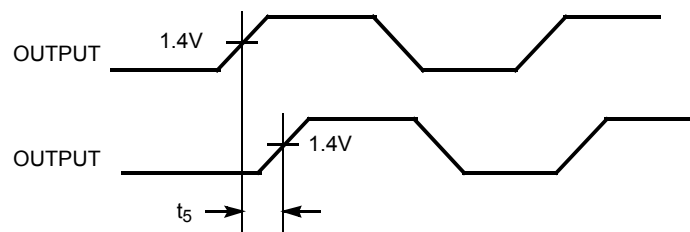
**Figure 3. Duty Cycle Timing**



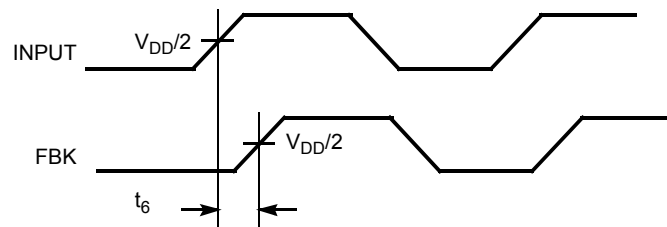
**Figure 4. All Outputs Rise/Fall Time**



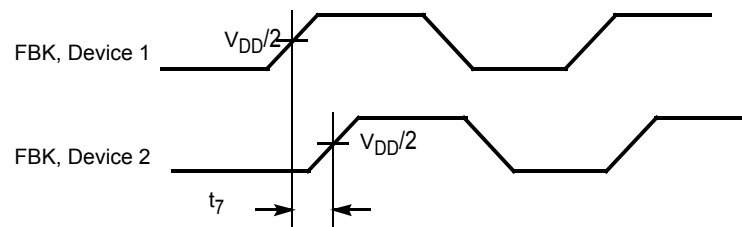
**Figure 5. Output-Output Skew**



**Figure 6. Input-Output Propagation Delay**



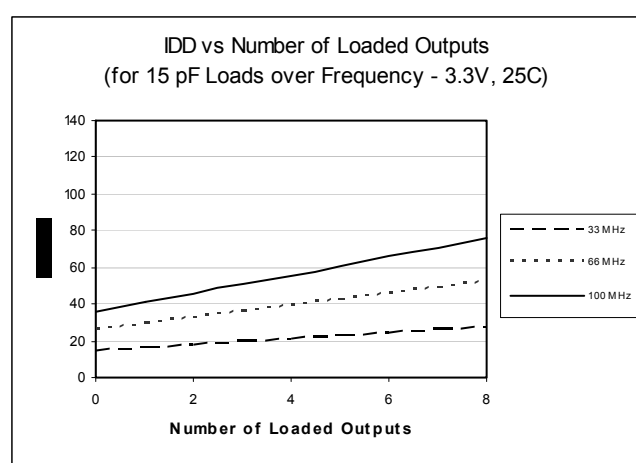
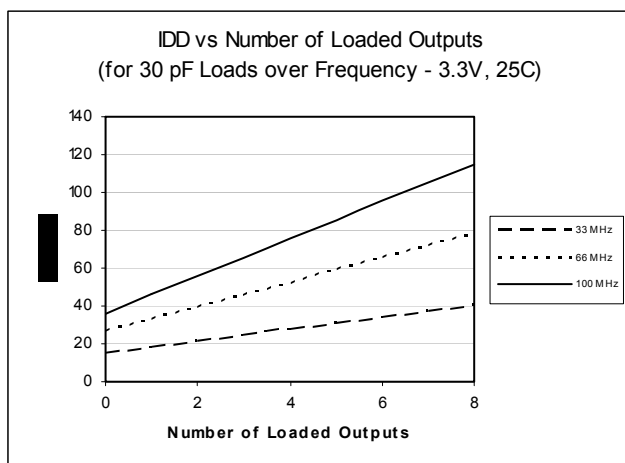
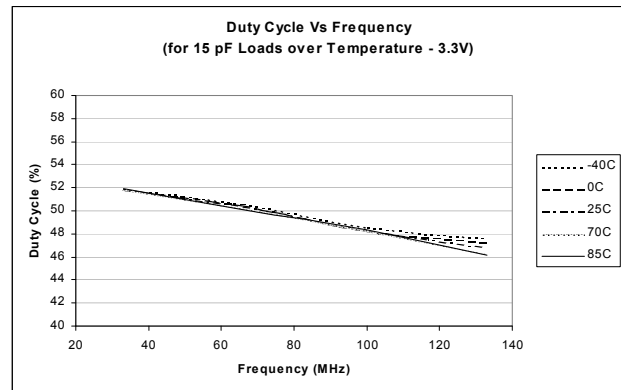
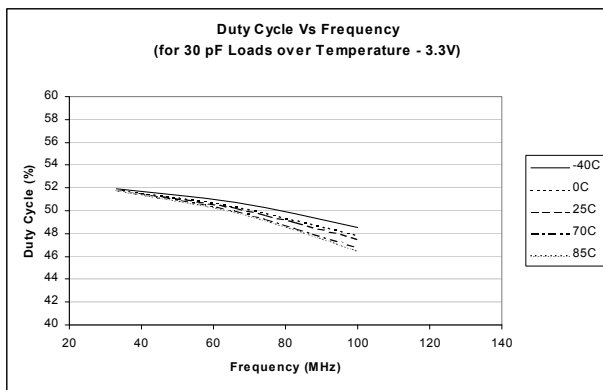
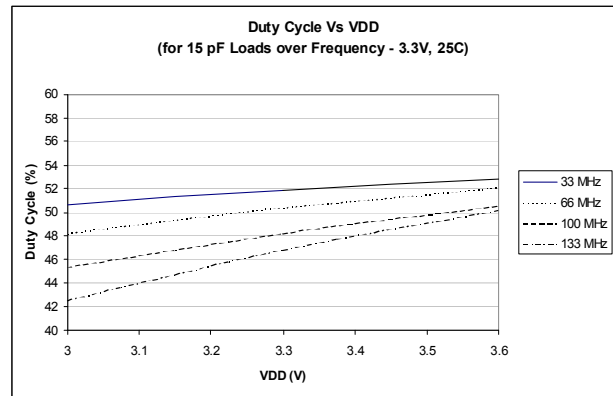
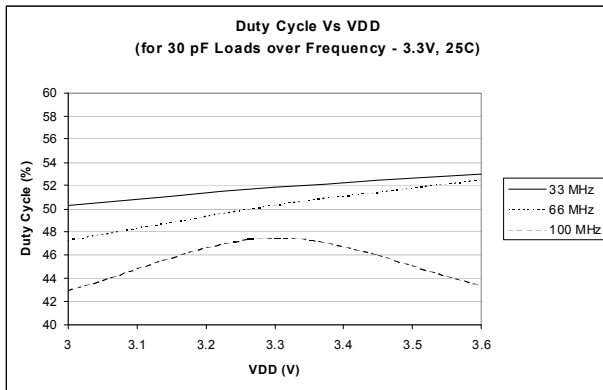
**Figure 7. Device-Device Skew**





## Typical Duty Cycle and $I_{DD}$ Trends

For CY2308-1, 2, 3, 4 [16, 17]



### Notes

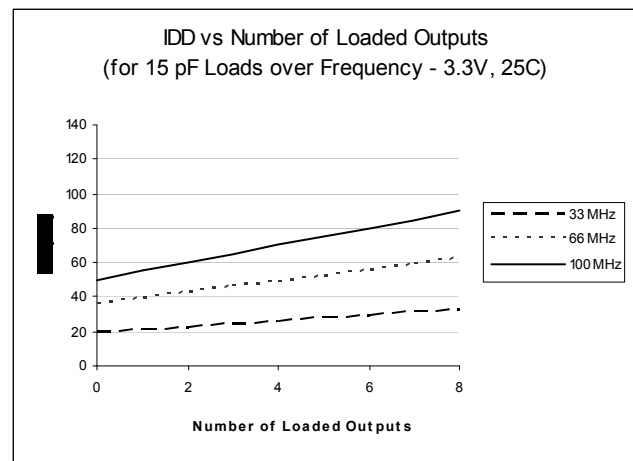
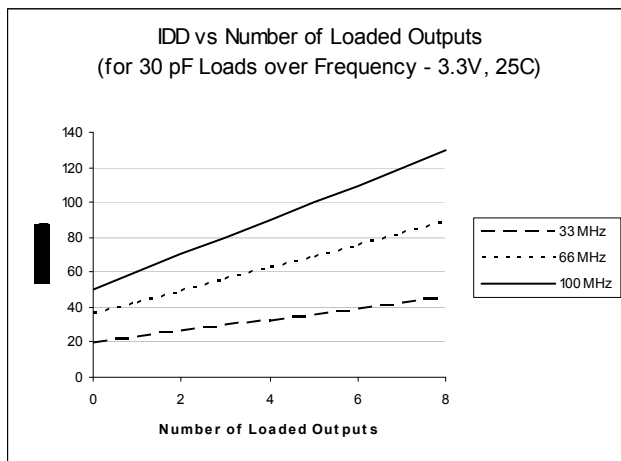
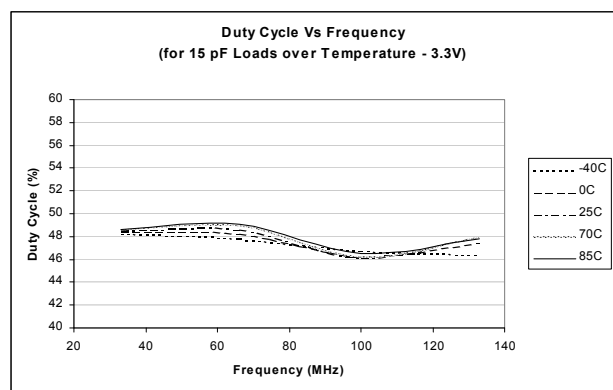
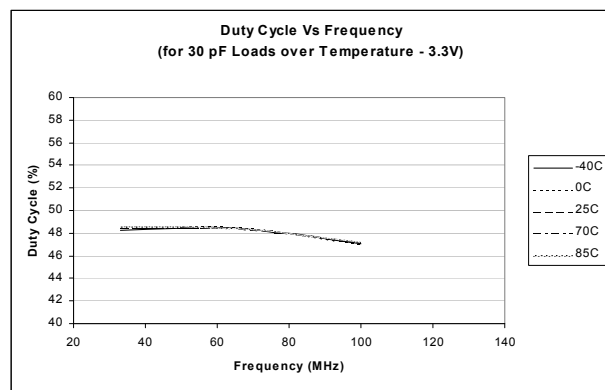
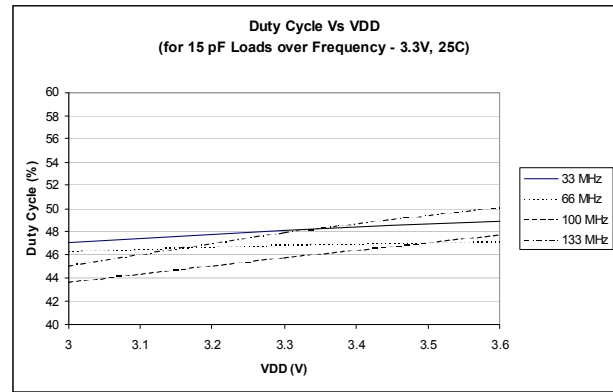
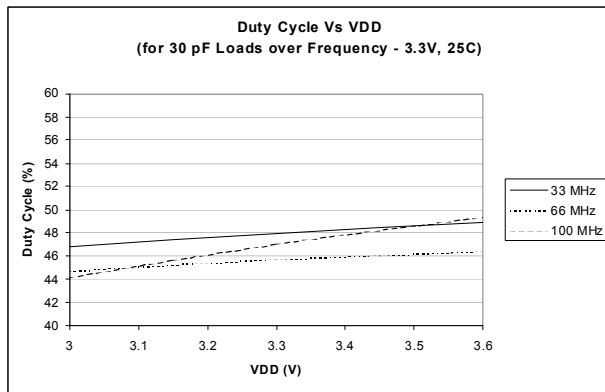
16. Duty cycle is taken from typical chip measured at 1.4 V.

17.  $I_{DD}$  data is calculated from  $I_{DD} = I_{CORE} + nCVf$ , where  $I_{CORE}$  is the unloaded current.

(n = number of outputs; C = Capacitance load per output (F); V = Voltage supply (V); f = frequency (Hz).

## Typical Duty Cycle and $I_{DD}$ Trends

For CY2308-1H, 5H [18, 19]

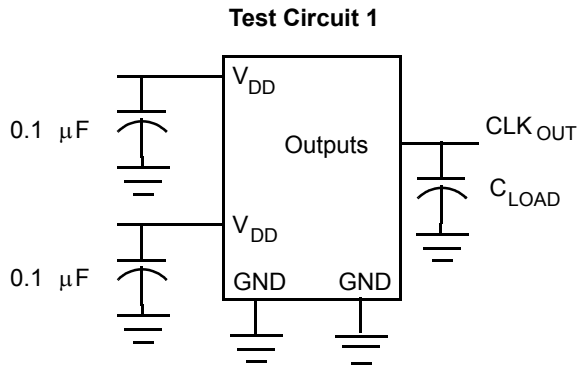


### Notes

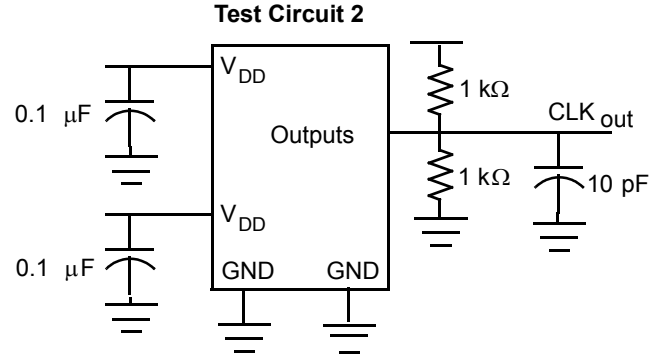
18. Duty cycle is taken from typical chip measured at 1.4 V.

19.  $I_{DD}$  data is calculated from  $I_{DD} = I_{CORE} + nCVf$ , where  $I_{CORE}$  is the unloaded current.  
 (n = number of outputs; C = Capacitance load per output (F); V = Voltage supply (V); f = frequency (Hz).

## Test Circuits



Test Circuit for all parameters except  $t_g$



Test Circuit for  $t_g$ , Output slew rate on -1H, -5H device

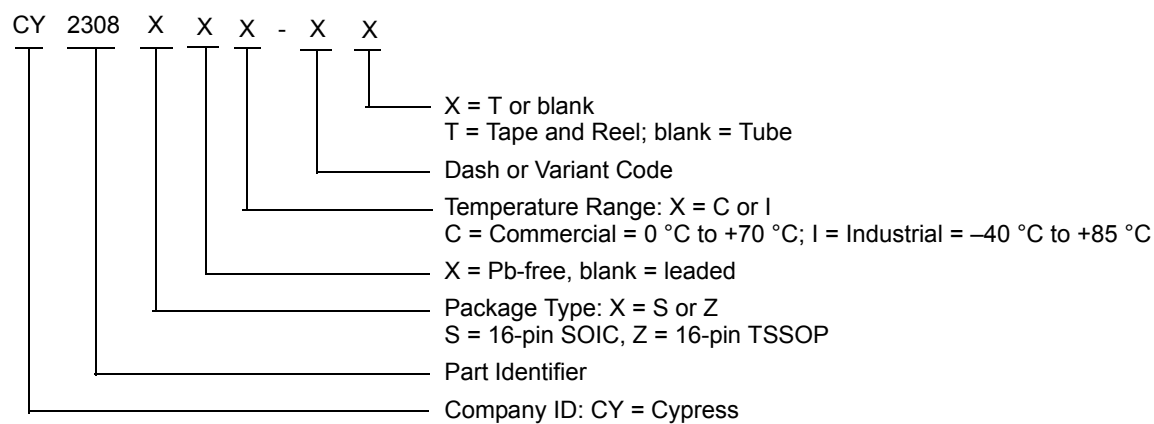
## Ordering Information

| Ordering Code  | Package Type                 | Operating Range |
|----------------|------------------------------|-----------------|
| <b>Pb-free</b> |                              |                 |
| CY2308SXC-1    | 16-pin SOIC                  | Commercial      |
| CY2308SXC-1T   | 16-pin SOIC – Tape and Reel  | Commercial      |
| CY2308SXI-1    | 16-pin SOIC                  | Industrial      |
| CY2308SXI-1T   | 16-pin SOIC – Tape and Reel  | Industrial      |
| CY2308SXC-1H   | 16-pin SOIC                  | Commercial      |
| CY2308SXC-1HT  | 16-pin SOIC – Tape and Reel  | Commercial      |
| CY2308SXI-1H   | 16-pin SOIC                  | Industrial      |
| CY2308SXI-1HT  | 16-pin SOIC – Tape and Reel  | Industrial      |
| CY2308ZXC-1H   | 16-pin TSSOP                 | Commercial      |
| CY2308ZXC-1HT  | 16-pin TSSOP – Tape and Reel | Commercial      |
| CY2308ZXI-1H   | 16-pin TSSOP                 | Industrial      |
| CY2308ZXI-1HT  | 16-pin TSSOP – Tape and Reel | Industrial      |
| CY2308SXC-2    | 16-pin SOIC                  | Commercial      |
| CY2308SXC-2T   | 16-pin SOIC – Tape and Reel  | Commercial      |
| CY2308SXI-2    | 16-pin SOIC                  | Industrial      |
| CY2308SXI-2T   | 16-pin SOIC – Tape and Reel  | Industrial      |
| CY2308SXC-3    | 16-pin SOIC                  | Commercial      |
| CY2308SXC-3T   | 16-pin SOIC – Tape and Reel  | Commercial      |
| CY2308SXI-3    | 16-pin SOIC                  | Industrial      |
| CY2308SXI-3T   | 16-pin SOIC – Tape and Reel  | Industrial      |
| CY2308SXC-4    | 16-pin SOIC                  | Commercial      |
| CY2308SXC-4T   | 16-pin SOIC – Tape and Reel  | Commercial      |
| CY2308SXI-4    | 16-pin SOIC                  | Industrial      |
| CY2308SXI-4T   | 16-pin SOIC – Tape and Reel  | Industrial      |

**Note**

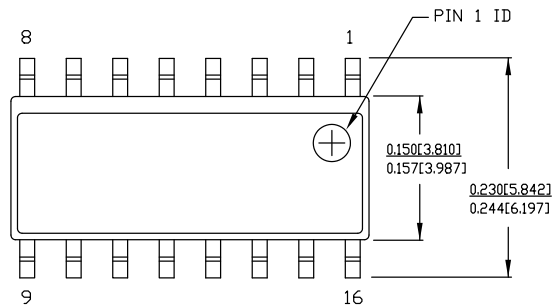
20. Not recommended for new designs.

## Ordering Code Definitions



## Package Diagrams

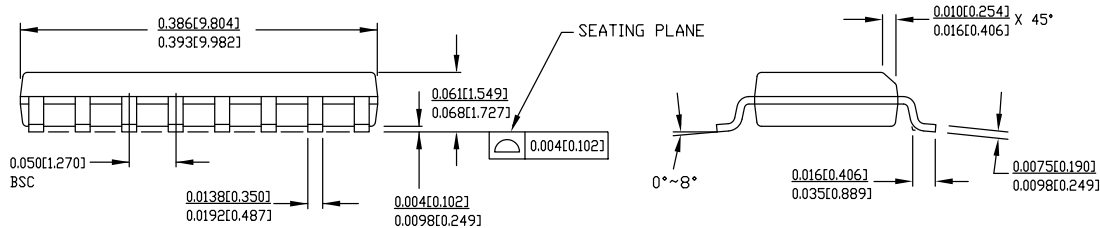
**Figure 8. 16-pin SOIC (150 Mil) S16.15/SZ16.15 Package Outline, 51-85068**



NOTE:

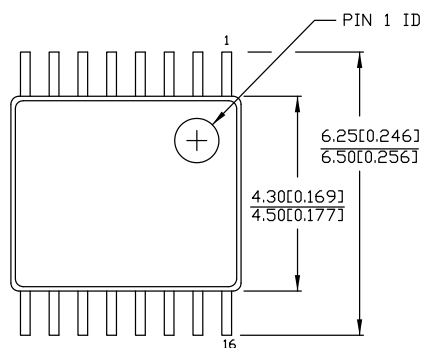
1. DIMENSIONS IN INCHES[MM] **MAX.**
2. REFERENCE JEDEC MS-012
3. PACKAGE WEIGHT : refer to PMDD spec. 001-04308

| PART #  |                |
|---------|----------------|
| S16.15  | STANDARD PKG.  |
| SZ16.15 | LEAD FREE PKG. |



51-85068 \*E

**Figure 9. 16-pin TSSOP 4.40 mm Body Z16.173 Package Outline, 51-85091**

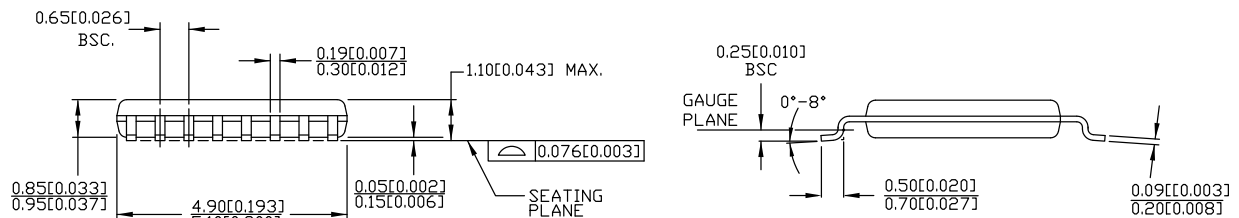


DIMENSIONS IN MM[INCHES] **MIN.**  
**MAX.**

REFERENCE JEDEC MO-153

PACKAGE WEIGHT 0.05gms

| PART #   |                |
|----------|----------------|
| Z16.173  | STANDARD PKG.  |
| ZZ16.173 | LEAD FREE PKG. |



51-85091 \*E

## Acronyms

**Table 1. Acronyms Used in this Document**

| Acronym | Description       |
|---------|-------------------|
| FBK     | Feedback          |
| PLL     | Phase Locked Loop |
| MUX     | Multiplexer       |

## Document Conventions

### Units of Measure

**Table 2. Units of Measure**

| Symbol | Unit of Measure             | Symbol | Unit of Measure               |
|--------|-----------------------------|--------|-------------------------------|
| °C     | degree Celsius              | μW     | microwatt                     |
| dB     | decibels                    | mA     | milliampere                   |
| fC     | femtocoulomb                | mm     | millimeter                    |
| fF     | femtofarad                  | ms     | millisecond                   |
| Hz     | hertz                       | mV     | millivolt                     |
| KB     | 1024 bytes                  | nA     | nanoampere                    |
| Kbit   | 1024 bits                   | ns     | nanosecond                    |
| kHz    | kilohertz                   | nV     | nanovolt                      |
| kΩ     | kilohm                      | Ω      | ohm                           |
| MHz    | megahertz                   | pA     | picoampere                    |
| MΩ     | megaohm                     | pF     | picofarad                     |
| μA     | microampere                 | pp     | peak-to-peak                  |
| μF     | microfarad                  | ppm    | parts per million             |
| μH     | microhenry                  | ps     | picosecond                    |
| μs     | microsecond                 | sps    | samples per second            |
| μV     | microvolt                   | σ      | sigma: one standard deviation |
| μVrms  | microvolts root-mean-square |        |                               |

## Errata

This section describes the errors and workaround solution for Cypress zero delay clock buffers belonging to the families CY2308. Details include errata trigger conditions, scope of impact and available workaround.

Contact your local Cypress Sales Representative if you have questions.

### Part Numbers Affected

| Part Number   | Device Characteristics |
|---------------|------------------------|
| CY2308SXC-1   | All Variants           |
| CY2308SXC-1T  | All Variants           |
| CY2308SXI-1   | All Variants           |
| CY2308SXI-1T  | All Variants           |
| CY2308SXC-3   | All Variants           |
| CY2308SXC-3T  | All Variants           |
| CY2308SXI-3   | All Variants           |
| CY2308SXI-3T  | All Variants           |
| CY2308SXC-1H  | All Variants           |
| CY2308SXC-1HT | All Variants           |
| CY2308SXI-1H  | All Variants           |
| CY2308SXI-1HT | All Variants           |
| CY2308ZI-1H   | All Variants           |
| CY2308ZI-1HT  | All Variants           |
| CY2308ZXC-1H  | All Variants           |
| CY2308ZXC-1HT | All Variants           |
| CY2308ZXI-1H  | All Variants           |
| CY2308ZXI-1HT | All Variants           |
| CY2308ZXI-1HT | All Variants           |

### CY2308 Errata Summary

| Items                       | Part Number | Silicon Revision | Fix Status                                              |
|-----------------------------|-------------|------------------|---------------------------------------------------------|
| 1. Start up lock time issue | All         | B                | Silicon fixed. New silicon available from WW 10 of 2013 |

### CY2308 Qualification Status

Product Status: In production

Qualification report last updated on 11/27/2012 (<http://www.cypress.com/?rID=72595>)



## 1. Start up lock time issue

### ■ Problem Definition

Output of CY2308 fails to lock within 1 ms (as per datasheet spec)

### ■ Parameters Affected

PLL lock time

### ■ Trigger Condition(s)

Powers up the device when the reference input clock is not present

### ■ Scope of Impact

The device does not lock

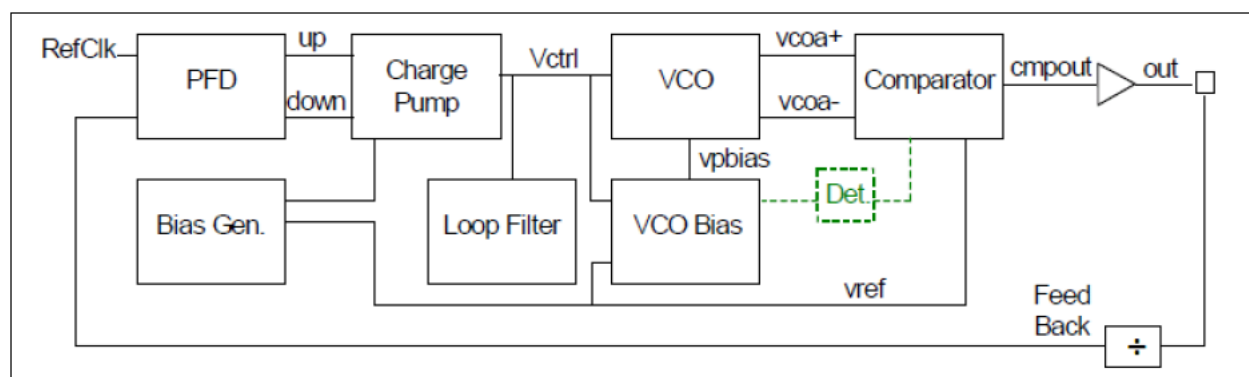
### ■ Workaround

Apply reference input (RefClk) before power-up ( $V_{DD}$ ). If reference input is present during power up, the input noise will not propagate to output and device will start normally without problems.

### ■ Fix Status

This issue is due to design marginality where input noise propagates to output in the absence of a reference input signal during power-up, and prevents device start-up. Two minor design modifications have been made to address this problem.

- Addition of VCO bias detector block as shown in the following figure which keeps comparator power down till VCO bias is present and thereby eliminating the propagation of noise to feedback.
- Bias generator enhancement for successful initialization.



## Document History Page

| Document Title: CY2308, 3.3 V Zero Delay Buffer<br>Document Number: 38-07146 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|------------------------------------------------------------------------------|---------|-----------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                         | ECN     | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| **                                                                           | 110255  | SZV             | 12/17/01        | Changed from Specification number: 38-00528 to 38-07146                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| *A                                                                           | 118722  | RGL             | 10/31/02        | Added Note 4.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| *B                                                                           | 121832  | RBI             | 12/14/02        | Power up requirements added to Operating Conditions Information                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| *C                                                                           | 235854  | RGL             | 06/24/04        | Added Pb-free Devices                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| *D                                                                           | 310594  | RGL             | 02/09/05        | Removed obsolete parts in the ordering information table<br>Specified typical value for cycle-to-cycle jitter                                                                                                                                                                                                                                                                                                                                                                                                                                |
| *E                                                                           | 1344343 | KVM / VED       | 08/20/07        | Brought the Ordering Information Table up to date: removed three obsolete parts and added two parts<br>Changed titles to tables that are specific to commercial and industrial temperature ranges                                                                                                                                                                                                                                                                                                                                            |
| *F                                                                           | 2568575 | AESA            | 09/19/08        | Updated template. Added Note 20 "Not recommended for new designs."<br>Changed IDD (PD mode) from 12.0 to 25.0 $\mu$ A for Commercial and Industrial Temperature Devices<br>Deleted Duty Cycle parameters for $F_{out} < 50$ MHz<br>Removed CY2308SI-4, CY2308SI-4T and CY2308SC-5HT.                                                                                                                                                                                                                                                         |
| *G                                                                           | 2632364 | KVM             | 01/08/09        | Corrected TSSOP package size (from 150 mil to 4.4 mm) in Ordering Information table                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| *H                                                                           | 2673353 | KVM / PYRS      | 03/13/09        | Reverted $I_{DD}$ (PD mode) and Duty Cycle parameters back to the values in revision *E:<br>Changed $I_{DD}$ (PD mode) from 25 to 12 $\mu$ A for commercial temperature devices<br>Added Duty Cycle parameters for $F_{out} < 50$ MHz for commercial and industrial devices.                                                                                                                                                                                                                                                                 |
| *I                                                                           | 2897373 | CXQ             | 03/22/10        | Updated <a href="#">Ordering Information</a> .<br>Updated <a href="#">Package Diagrams</a> .<br>Updated copyright section.                                                                                                                                                                                                                                                                                                                                                                                                                   |
| *J                                                                           | 2971365 | BASH            | 07/06/10        | Updated input to output skew and power down current number in Functional Description, page 1<br>Update pin descriptions in 'Pin Description' column, Table1, page 2<br>Added 'Input Frequency' parameter and output frequency for -1H and -5H in 'Switching Characteristics Table' and removed footnote, page 4, 5, and 7.<br>Modified Description on page 1 and page 3 to make clear that user has to select one of the outputs to drive feedback.<br>Added footnote in 'Available CY2308 Configurations' Table, page 3, for clarification. |
| *K                                                                           | 3047133 | CXQ             | 10/04/2010      | No technical updates.<br>Completing Sunset Review.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| *L                                                                           | 3055192 | CXQ             | 10/11/2010      | Updated <a href="#">Ordering Information</a> (Removed part CY2308SXI-5H and CY2308SXI-5HI).                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| *M                                                                           | 3402187 | BASH            | 10/11/2011      | Updated <a href="#">Ordering Information</a> (Removed prune part numbers CY2308SI-1H and CY2308SI-1HT).<br>Updated <a href="#">Package Diagrams</a> .<br>Updated to new template.                                                                                                                                                                                                                                                                                                                                                            |
| *N                                                                           | 4128657 | CINM            | 10/23/2013      | Updated <a href="#">Package Diagrams</a> :<br>spec 51-85068 – Changed revision from *D to *E.<br>Updated to new template.<br>Completing Sunset Review.                                                                                                                                                                                                                                                                                                                                                                                       |
| *O                                                                           | 4307800 | CINM            | 03/13/2014      | Added <a href="#">Errata</a> .                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |

**Document History Page** (continued)

| Document Title: CY2308, 3.3 V Zero Delay Buffer<br>Document Number: 38-07146 |         |                 |                 |                                                                                                                                                                                                                                                                                                                           |
|------------------------------------------------------------------------------|---------|-----------------|-----------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                         | ECN     | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                     |
| *P                                                                           | 4578443 | TAVA            | 11/25/2014      | Updated <a href="#">Functional Description</a> :<br>Added "For a complete list of related documentation, click <a href="#">here</a> ." at the end.<br>Updated <a href="#">Ordering Information</a> :<br>Removed pruned part CY2308SI-2T.<br>Removed obsolete parts CY2308SI-1T, CY2308ZI-1H, CY2308ZI-1HT and CY2308SI-2. |
| *Q                                                                           | 5272607 | PSR             | 05/16/2016      | Updated <a href="#">Zero Delay and Skew Control</a> :<br>Updated description (Updated title and link for AN1234).<br>Added <a href="#">Thermal Resistance</a> .<br>Updated to new template.                                                                                                                               |
| *R                                                                           | 5516682 | TAVA            | 11/10/2016      | Updated to new template.<br>Completing Sunset Review.                                                                                                                                                                                                                                                                     |
| *S                                                                           | 5638394 | PRBD            | 02/21/2017      | Corrected typo and added more clarity in <a href="#">Errata</a> .<br>Updated the template.                                                                                                                                                                                                                                |
| *T                                                                           | 5987007 | AESATMP8        | 12/07/2017      | Updated logo and Copyright.                                                                                                                                                                                                                                                                                               |

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